NSN 5962-00-626-1926



Memory Microcircuit - Page 1 of 1 View Online at https://aerobasegroup.com/nsn/5962-00-626-1926 **Body Length:** Between 0.750 inches and 0.795 inches **Body Width:** Between 0.245 inches and 0.300 inches **Body Height:** Between 0.120 inches and 0.195 inches **Maximum Power Dissipation Rating:** 470.0 milliwatts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **Features Provided:** Hermetically sealed and monolithic and positive outputs and wire-or outputs **Inclosure Material:** Ceramic and glass **Inclosure Configuration:** Dual-in-line **Output Logic Form:** Transistor-transistor logic **Input Circuit Pattern:** 12 input **Case Outline Source And Designator:** -0-001-ag joint electron device engineering council **Terminal Surface Treatment:** Solder **Voltage Rating And Type Per Characteristic:** -1.5 volts power source and 5.5 volts power source **Memory Device Type:** Rom **Memory Capacity:** Unknown **Terminal Type And Quantity:** 16 printed circuit Shelf Life:

N/a **Unit Of Measure: Demilitarization:** Yes - demil/mli Fiig:

A458a0